

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CEO}	-50V
I _C	-100mA
R ₁	4.7kΩ

Features

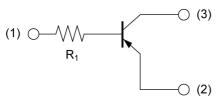
- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC143T series

Application

INVERTER, INTERFACE, DRIVER

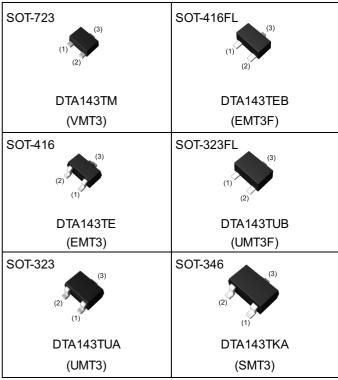
Inner circuit

DTA143TM/ DTA143TEB/ DTA143TUB

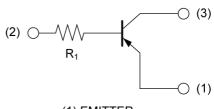


- (1) BASE
- (2) EMITTER
- (3) COLLECTOR

Outline



DTA143TE/ DTA143TUA/ DTA143TKA



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA143TM	SOT-723	1212	T2L	180	8	8000	93
DTA143TEB	SOT-416FL	1616	TL	180	8	3000	93
DTA143TE	SOT-416	1616	TL	180	8	3000	93
DTA143TUB	SOT-323FL	2021	TL	180	8	3000	93
DTA143TUA	SOT-323	2021	T106	180	8	3000	93
DTA143TKA	SOT-346	2928	T146	180	8	3000	93

• Absolute maximum ratings ($T_a = 25$ °C)

Pa	arameter	Symbol	Values	Unit
Collector-base voltage	Collector-base voltage			V
Collector-emitter voltage			-50	V
Emitter-base voltage		V _{EBO}	-5	V
Collector current			-100	mA
	DTA143TM		150	mW
	DTA143TEB		150	
Davie a discipation	DTA143TE	P _D *1	150	
Power dissipation	DTA143TUB	P _D .	200	
	DTA143TUA		200	
DTA143TKA			200	
Junction temperature		T _j	150	°C
Range of storage temperar	ture	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Downwater	Curah al	Conditions	Values			l lait	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	I _C = -50μA	-50	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-50	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = -50μA	-5	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = -50V	-	1	-500	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = -4V	-	-	-500	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -5mA, I_B = -0.25mA$	-	-	-300	mV	
DC current gain	h _{FE}	$V_{CE} = -5V$, $I_C = -1mA$	100	250	600	-	
Input resistance	R ₁	-	3.29	4.7	6.11	kΩ	
Transition frequency	f _T *2	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz	

^{*1} Each terminal mounted on a reference land.

^{*2} Characteristics of built-in transistor

● Electrical characteristic curves(Ta=25°C)

Fig.1 Grounded emitter propagation characteristics

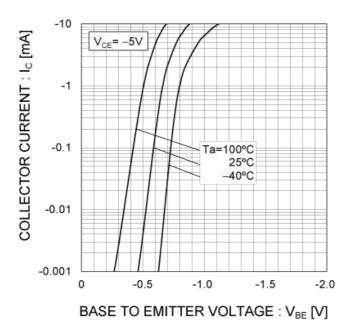


Fig.2 Grounded emitter output characteristics

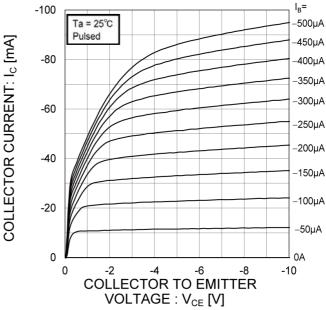


Fig.3 DC Current gain vs. Collector Current

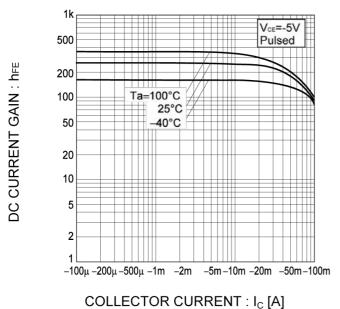
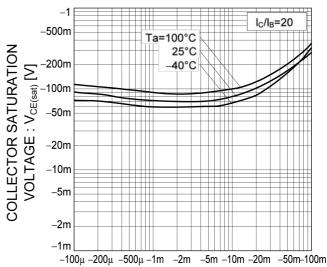
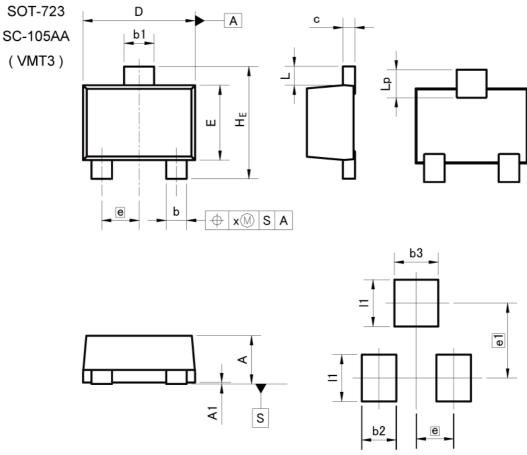


Fig.4 Collector-emitter saturation voltage vs. Collector Current



COLLECTOR CURRENT : I_C [A]



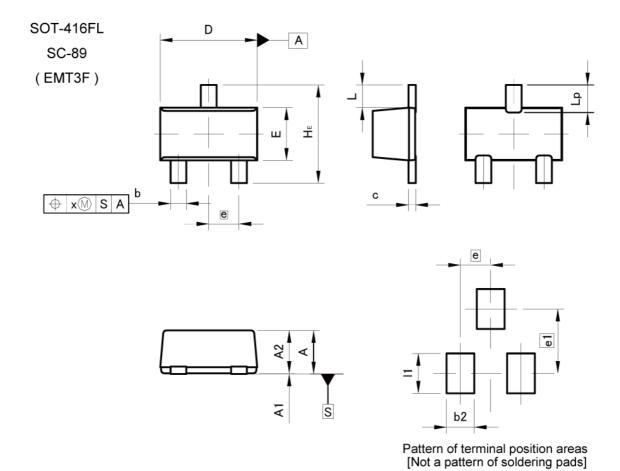
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	=	0.10	33	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	11 0	0.37	544	0.015
b3	226	0.47	822	0.019
e1	0.80		0.0	031
11	==	0.50	277	0.020

Dimension in mm/inches



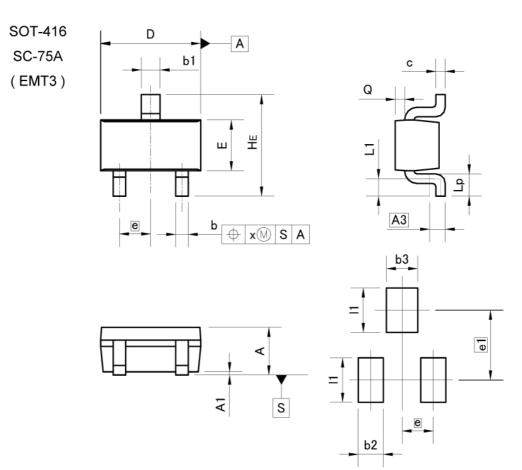


DIM -	MILIM	ETERS	INCHES	
DIM [MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
e 0.50		0.0	20	
HE	1.50	1.70	0.059	0.067
L	0.37		0.0	15
Lp	0.35	0.55	0.014	0.022
х		0.10	-	0.004

DIM -	MILIMETERS		INCHES	
DIM [MIN	MAX	MIN	MAX
b2	= 1	0.46	_	0.018
e1	4:	1.05	-	0.041
11	=	0.65	=	0.026

Dimension in mm/inches





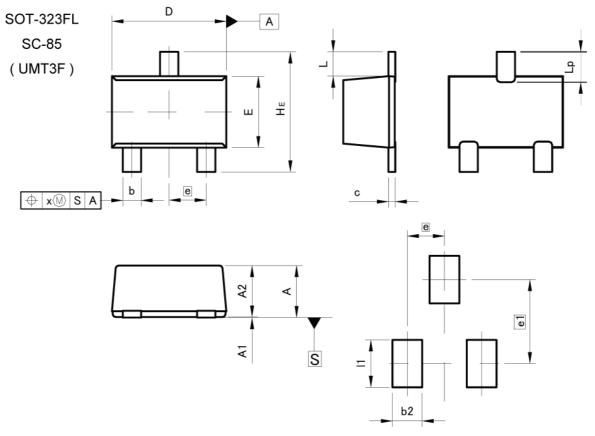
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	. es	0.004	÷
Lp	0.15	=:	0.006	255
Q	0.05	0.25	0.002	0.010
х	2 7	0.10	_	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 48	0.50	; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; 	0.020
e1	1.10		0.0	043
11		0.70	-	0.028

Dimension in mm/inches





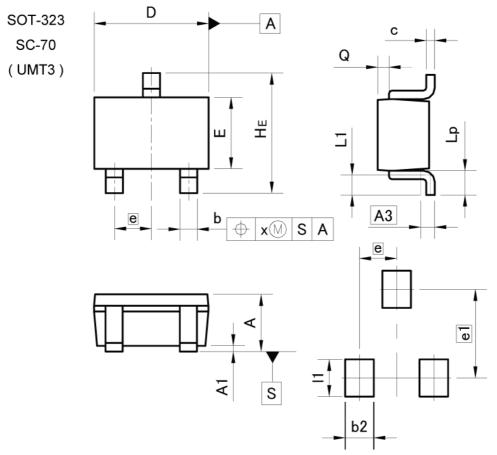
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65 0.026		26	
HE	2.00	2.20	0.079	0.087
L	0.425		0.0	17
Lp	0.43	0.63	0.017	0.025
х	==:	0.10	=	0.004

DIM	MILIME	TERS	INCH	HES
DIM	MIN	MAX	MIN	MAX
b2	- s	0.52	-	0.020
e1	1.47		0.0	58
11	 k	0.83	-	0.033

Dimension in mm/inches





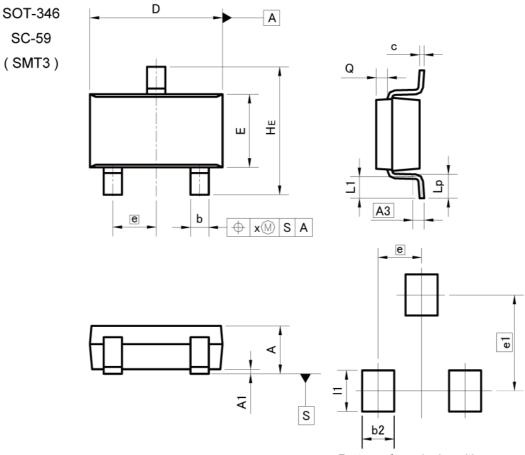
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIMETERS		INCHES	
DIM [MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u>e44</u> 8)	0.50	<u>~=</u>	0.020
e1	1.55		0.061	
11	₩.	0.65	1000	0.026

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	7,8	0.10	\$ 5	0.004
У	=0	0.10	97	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-2	0.60	3=	0.024
e1	2.10		0.083	
11		0.90	:=	0.035

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSIII
CLASSIV	CLASSIII	CLASSIII	CLASSIII

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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NSVMUN2237T1G NSVDTC143ZM3T5G SMUN5335DW1T2G SMUN5216DW1T1G